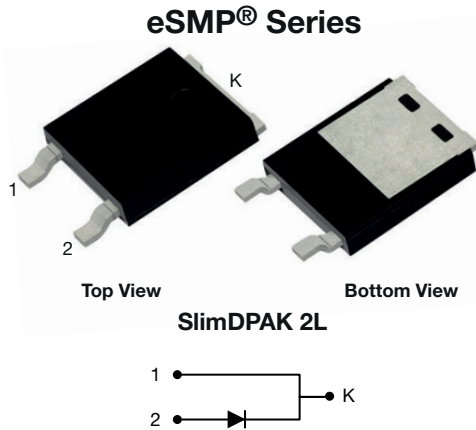


Surface-Mount ESD Capability Rectifier


 AUTOMOTIVE
GRADE

RoHS
COMPLIANT
HALOGEN
FREE

FEATURES

- Creepage and clearance distance 2.8 mm minimum
- Very low profile - typical height of 1.3 mm
- Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop
- ESD capability
- AEC-Q101 qualified
 - Automotive ordering code: base P/NHM3
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

LINKS TO ADDITIONAL RESOURCES



TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both industry and automotive on board charger (OBC) applications.

MECHANICAL DATA

Case: SlimDPAK 2L

Molding compound meets UL 94 V-0 flammability rating
 Base P/N-M3 - halogen-free, RoHS-compliant
 Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: as marked

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	8 A
V_{RRM}	400 V, 600 V
I_{FSM}	110 A
V_F at $I_F = 8$ A ($T_J = 125$ °C)	0.92 V
T_J max.	175 °C
Package	SlimDPAK 2L
Circuit configurations	Single

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)				
PARAMETER	SYMBOL	SE80PWTG	SE80PWTJ	UNIT
Device marking code		SE80PWTG	SE80PWTJ	
Maximum repetitive peak reverse voltage	V_{RRM}	400	600	V
Maximum average forward rectified current (Fig. 1)	$I_{F(AV)}^{(1)}$	8.0		A
	$I_{F(AV)}^{(2)}$	2.6		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	110		A
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +175		°C

Notes

(1) With infinite heatsink

(2) Free air, mounted on recommended copper pad area



ELECTRICAL CHARACTERISTICS ($T_J = 25\text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Maximum Instantaneous forward voltage	$I_F = 4.0\text{ A}$	$T_J = 25\text{ }^\circ\text{C}$	$V_F^{(1)}$	0.93	-	V
	$I_F = 8.0\text{ A}$			1.01	1.12	
	$I_F = 4.0\text{ A}$	$T_J = 125\text{ }^\circ\text{C}$		0.82	-	
	$I_F = 8.0\text{ A}$			0.92	1.07	
Reverse current	Rated V_R	$T_J = 25\text{ }^\circ\text{C}$	$I_R^{(2)}$	-	15	μA
		$T_J = 125\text{ }^\circ\text{C}$		19	150	
Typical reverse recovery time	$I_F = 0.5\text{ A}, I_R = 1.0\text{ A}, I_{rr} = 0.25\text{ A}$		t_{rr}	2400	-	ns
Typical junction capacitance	4.0 V, 1 MHz		C_J	58	-	pF

Notes

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
(2) Pulse test: pulse width $\leq 40\text{ ms}$

THERMAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)(2)}$	76	95	$^\circ\text{C/W}$
	$R_{\theta JM}^{(3)}$	2.4	3	

Notes

- (1) The heat generated must be less than thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$
(2) Thermal resistance junction to ambient to follow JEDEC[®] 51-2A, device mounted on FR4 PCB, 2 oz., standard footprint
(3) Thermal resistance junction-to-mount to follow JEDEC[®] 51-14 transient dual interface test method (TDIM)

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS					
$(T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)					
STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE
AEC-Q101-001	Human body model (contact mode)	$C = 100\text{ pF}, R = 1.5\text{ k}\Omega$	V_C	H3B	$> 8\text{ kV}$

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
SE80PWTJ-M3/I	0.184	I	4500	13" diameter plastic tape and reel
SE80PWTJHM3/I ⁽¹⁾	0.184	I	4500	13" diameter plastic tape and reel

Note

- (1) AEC-Q101 qualified



RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

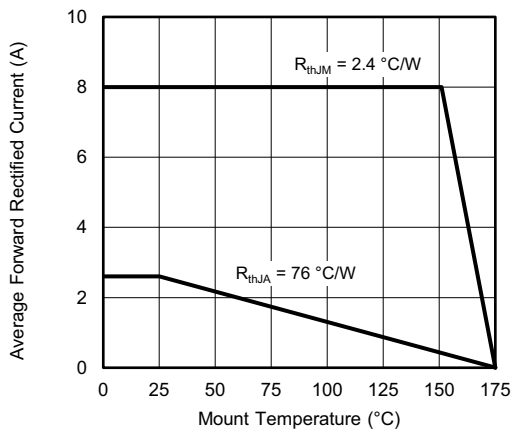


Fig. 1 - Maximum Forward Current Derating Curve

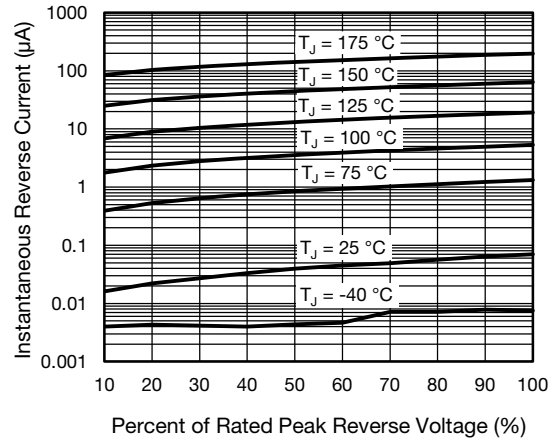


Fig. 4 - Typical Reverse Leakage Characteristics

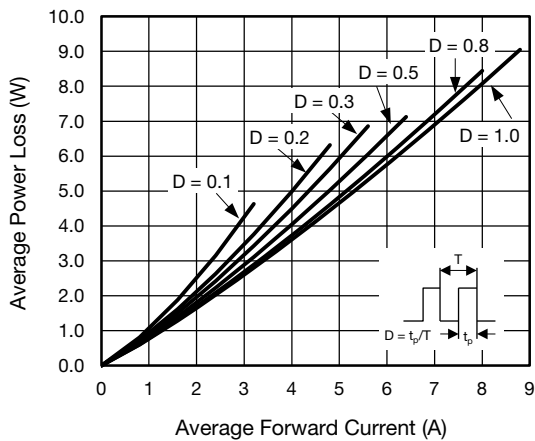


Fig. 2 - Forward Power Loss Characteristics

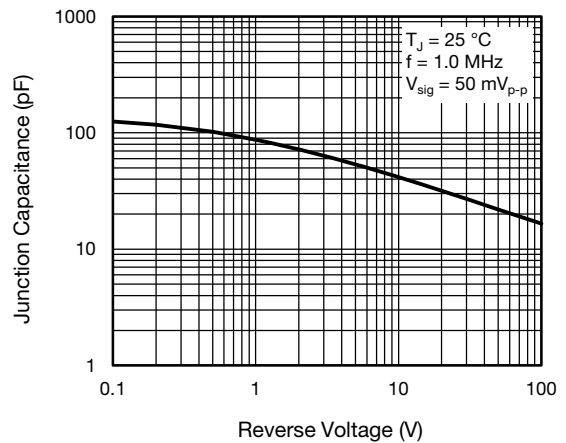


Fig. 5 - Typical Junction Capacitance

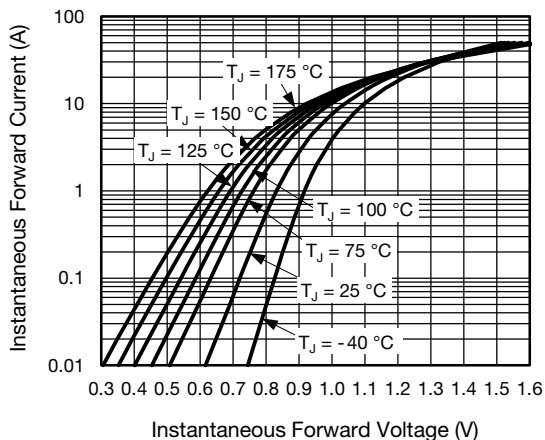


Fig. 3 - Typical Instantaneous Forward Characteristics

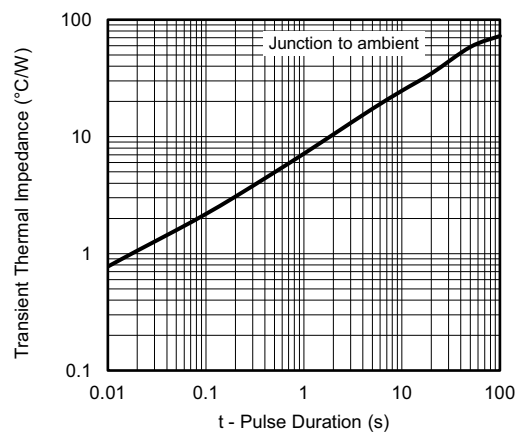
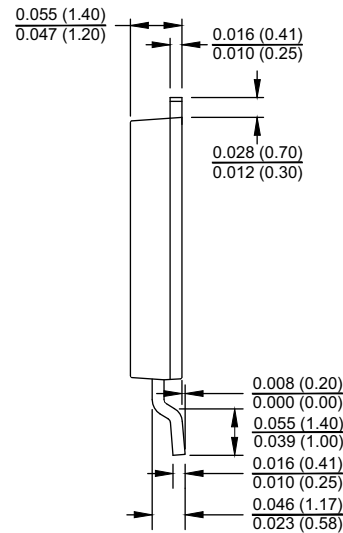
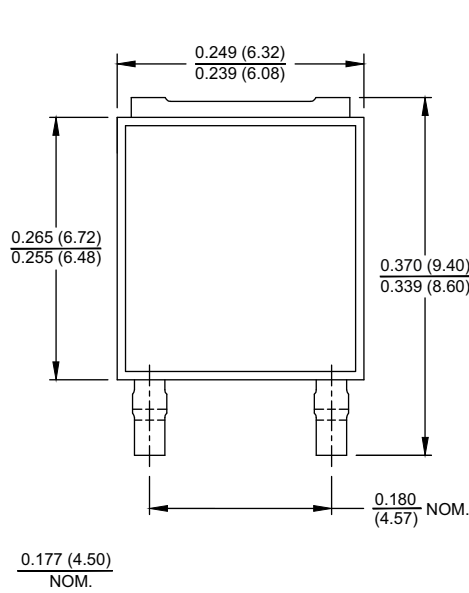


Fig. 6 - Typical Transient Thermal Impedance

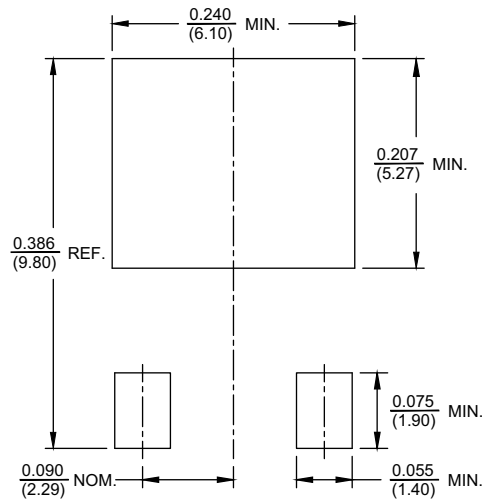
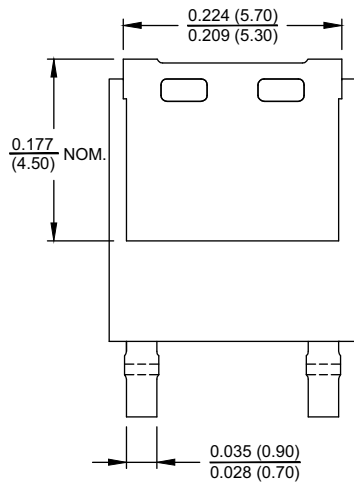


PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SlimDPAK 2L



Mounting Pad Layout



Note

- The suggested mounting pad layout is provided for reference only, as actual pad layouts may vary depending on application



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